Product Specification
(Preliminary)

Part Name: OEL Display Module
Part ID: UG-2864KLBEG01
Part ID: UG-2864KSWEG01
Doc No.:   SAS1-9050-B

Customer:
Approved by

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From: Univision Technology Inc.
Approved by

Univision Technology Inc.
8, Kebei RD 2, Science Park, Chu-Nan, Taiwan 350, R.O.C.

Notes:
1. Please contact Univision Technology Inc. before assigning your product based on this module specification
2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by Univision Technology Inc. for any intellectual property claims or other problems that may result from application based on the module described herein.

Revised History

Part Number	Revision	Revision Content	Revised on
UG-2864HMBEG01	A	New	February 17, 2009

UG-2864HMBEG01	B	Page 5~6 *Section 1.6*
		  Update Application Circuit
		Page 7 *Section 2*
		  Update Absolute Maximum Ratings
		Page 8~9 *Section 3.1 & 3.2*
		  Modify Brightness
		   V_{CC} Supplied Externally
		    (Min/Typ) 80/100➔100/120
		   V_{CC} Generated by Internal DC/DC
		    (Min/Typ) 50/60➔80/100
		  Update DC Characteristics
		Page 15 *Section 4.4*
		  Update Initialization
			June 5, 2009

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Contents

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1. Basic Specifications

1.1 Display Specifications

1) Display Mode: Passive Matrix
2) Display Color: Area Color (Light Blue & Yellow)
3) Drive Duty: 1/64 Duty

1.2 Mechanical Specifications

1) Outline Drawing: According to the annexed outline drawing
2) Number of Pixels: 128×64
3) Panel Size: $26.70 \times 19.26 \times 1.45$ (mm)
4) Active Area: 21.744×10.864 (mm)
5) Pixel Pitch: 0.17×0.17 (mm)
6) Pixel Size: 0.154×0.154 (mm)
7) Weight: 1.54 (g)

1.3 Active Area & Pixel Construction

P0.17x128-0.016=21.744

Yellow
128 x 16

"A"

0.17
0.154

0.17
0.154

P0.17x(64+2)-0.016=11.204
P0.17x16-0.016=2.704
P0.17x48-0.016=8.144
0.17x2+0.016=0.356

Light Blue
128 x 48

Segment 127
(Column 1)

Segment 0
(Column 128)

Common 32
(Row 63)

Common 0
(Row 64)

Common 57
(Row 17)

Common 23
(Row 18)

Common 56
(Row 15)

Common 24
(Row 16)

Common 63
(Row 1)

Common 31
(Row 2)

Detail "A"
Scale (10:1)

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1.4 Mechanical Drawing

Detail "A" Scale (10:1)

0.17
0.154
0.154
0.17

Segment 0 (Column 128)
Common 0 (Row 64)
Common 23 (Row 18)
Common 24 (Row 16)
Common 31 (Row 2)

Segment 127 (Column 1)
Common 32 (Row 63)
Common 57 (Row 17)
Common 56 (Row 15)
Common 63 (Row 1)

Yellow 128 x 16
Light Blue 128 x 48

P0.17x128-0.016=21.744

0.17x2+0.016=0.356
P0.17x48-0.016=8.144
P0.17x16-0.016=2.704
P0.17x(64+2)-0.016=11.204

(20.86)
(10.55)
(1.6)
(1.613)

1.45±0.1
0.1±0.03

Glue
Contact Side
Contact Side
Remove Tape t=0.15mm Max
Polarizer t=0.2mm
3M #1318B 15x8x0.063mm

8
5
10

Active Area 0.96"
128 x 64 Pixels

26.7±0.2 (Panel Size)
26.7±0.2 (Cap Size)
25.7±0.5 (Polarizer)
23.744 (V/A)
21.744 (A/A)

0.5±0.5
(1.478)
(2.478)
(2.098)
(1.098)
0.5±0.5

11.204 (A/A)
13.204 (V/A)
14.4±0.5 (Polarizer)
15.5±0.2 (Cap Size)
19.26±0.2 (Panel Size)
(31.26)

2-R0.4±0.05
30
12±0.2
16±0.1 (Alignment Mark)
P0.70x(30-1)=20.3±0.05 (W0.40±0.03)
0.85±0.1
22±0.2
(2.35)

2±0.3
4
4.75
6.887
11
12±0.3

Notes:
1. Color: Light Blue & Yellow
2. Driver IC: SSD1306
3. FPC Number: UT-0206-P05
4. Interface: 8-bit 68XX/80XX Parallel, 3-/4-wire SPI, I2C
5. General Tolerance: ±0.30
6. The total thickness (1.55 Max) is without polarizer protective film & remove tape. The actual assembled total thickness with above materials should be 1.80 Max.

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UG-2864HMBEG01 Folding Type OEL Display Module
Pixel Number: 128 x 64, Area Color (2), COG Package

	Drawn	By	Date
	Humphrey Lin		20090120
E.E.	James Wang		20090120
Panel / E.	Ivy Lo		20090120
P.M.	Cherry Lin		20090120

Unless Otherwise Specified
Unit: mm
General Roughness: 1.17
Tolerance
Dimension: ±0.3
Angle: ±1

Customer Approval Signature

Drawing Number	DAX2864SDGF50	Rev. A
Material	Soda Lime / Polyimide	
Scale 1:1	Sheet 1 of 1	Size A3

Pin / Symbol table:

Pin	Symbol
1	N.C. (GND)
2	C2P
3	C2N
4	C1P
5	C1N
6	VBAT
7	N.C.
8	VSS
9	VDD
10	BS0
11	BS1
12	BS2
13	CS#
14	RES#
15	D/C#
16	R/W#
17	E/RD#
18	D0
19	D1
20	D2
21	D3
22	D4
23	D5
24	D6
25	D7
26	IREF
27	VCOMH
28	VCC
29	VLSS
30	N.C. (GND)

Item	Date	Remark
A	20090120	Original Drawing

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1.5 Pin Definition

| Pin Number	Symbol	Type	Function
Power Supply			
9	VDD	P	*Power Supply for Logic* This is a voltage supply pin. It must be connected to external source.
8	VSS	P	*Ground of Logic Circuit* This is a ground pin. It acts as a reference for the logic pins. It must be connected to external ground.
28	VCC	P	*Power Supply for OEL Panel* This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.
29	VLSS	P	*Ground of Analog Circuit* This is an analog ground pin. It should be connected to VSS externally.
Driver			
26	IREF	I	*Current Reference for Brightness Adjustment* This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5μA.
27	VCOMH	O	*Voltage Output High Level for COM Signal* This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
DC/DC Converter			
6	VBAT	P	*Power Supply for DC/DC Converter Circuit* This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to external source when the converter is used. It should be connected to VDD when the converter is not used.
4 / 5 2 / 3	C1P / C1N C2P / C2N	I	*Positive Terminal of the Flying Inverting Capacitor* *Negative Terminal of the Flying Boost Capacitor* The charge-pump capacitors are required between the terminals. They must be floated when the converter is not used.
Interface			
10 11 12	BS0 BS1 BS2	I	*Communicating Protocol Select* These pins are MCU interface selection input. See the following table: {subtable}
14	RES#	I	*Power Reset for Controller and Driver* This pin is reset signal input. When the pin is low, initialization of the chip is executed.

Interface selection subtable (for BS0/BS1/BS2):

	BS0	BS1	BS2
I2C	0	1	0
3-wire SPI	1	0	0
4-wire SPI	0	0	0
8-bit 68XX Parallel	0	0	1
8-bit 80XX Parallel	0	1	1

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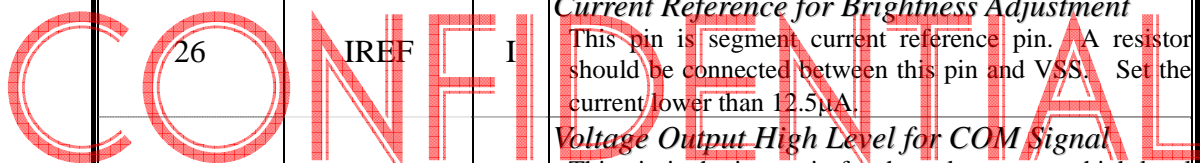
1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function
Interface (Continued)			
13	CS#	I	**Chip Select** This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.
15	D/C#	I	**Data/Command Control** This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.
17	E/RD#	I	**Read/Write Enable or Read** This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
16	R/W#	I	**Read/Write Select or Write** This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
18~25	D0~D7	I/O	**Host Data Input/Output Bus** These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
Reserve			
7	N.C.	-	**Reserved Pin** The N.C. pins between function pins are reserved for compatible and flexible design.
1, 30	N.C. (GND)	-	**Reserved Pin (Supporting Pin)** The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

1.6 Block Diagram

1.6.1 V_{CC} Supplied Externally
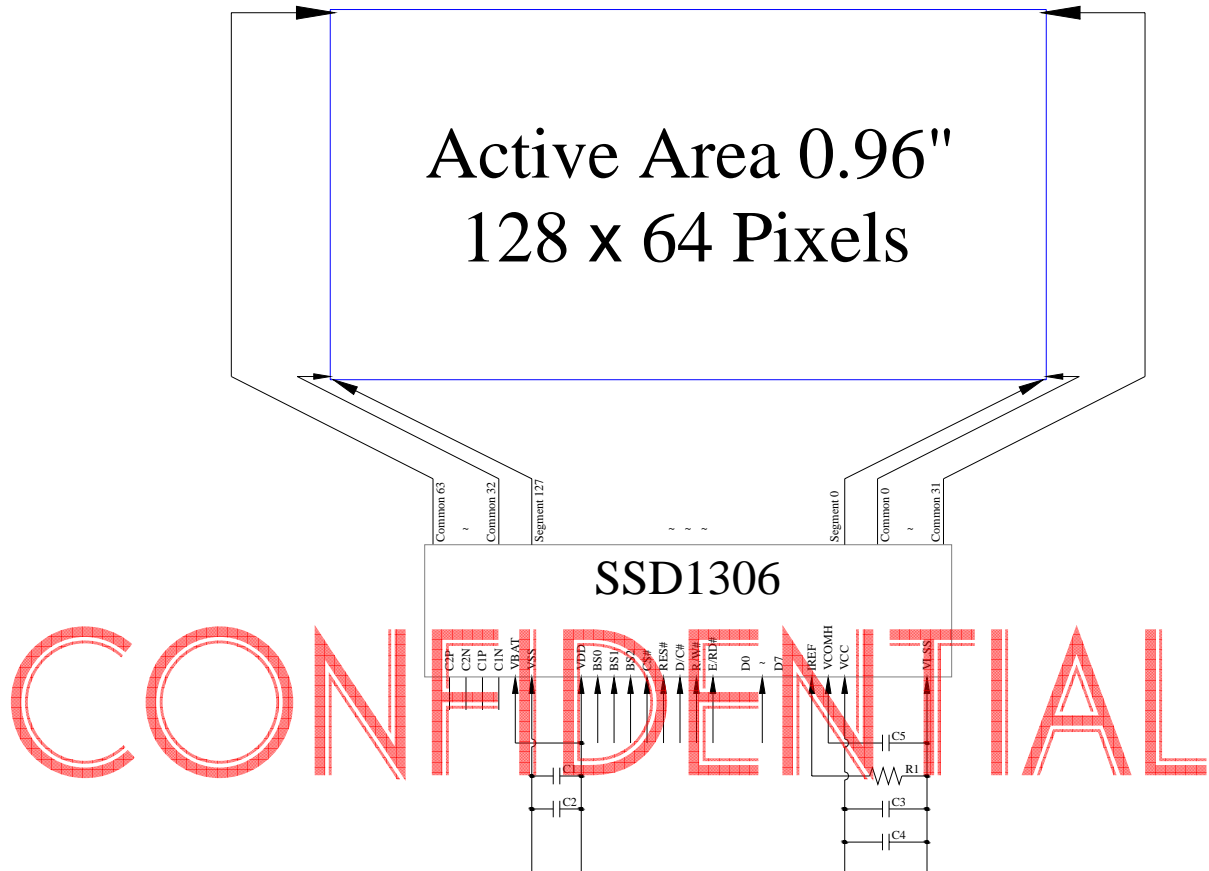
MCU Interface Selection: BS0, BS1 and BS2
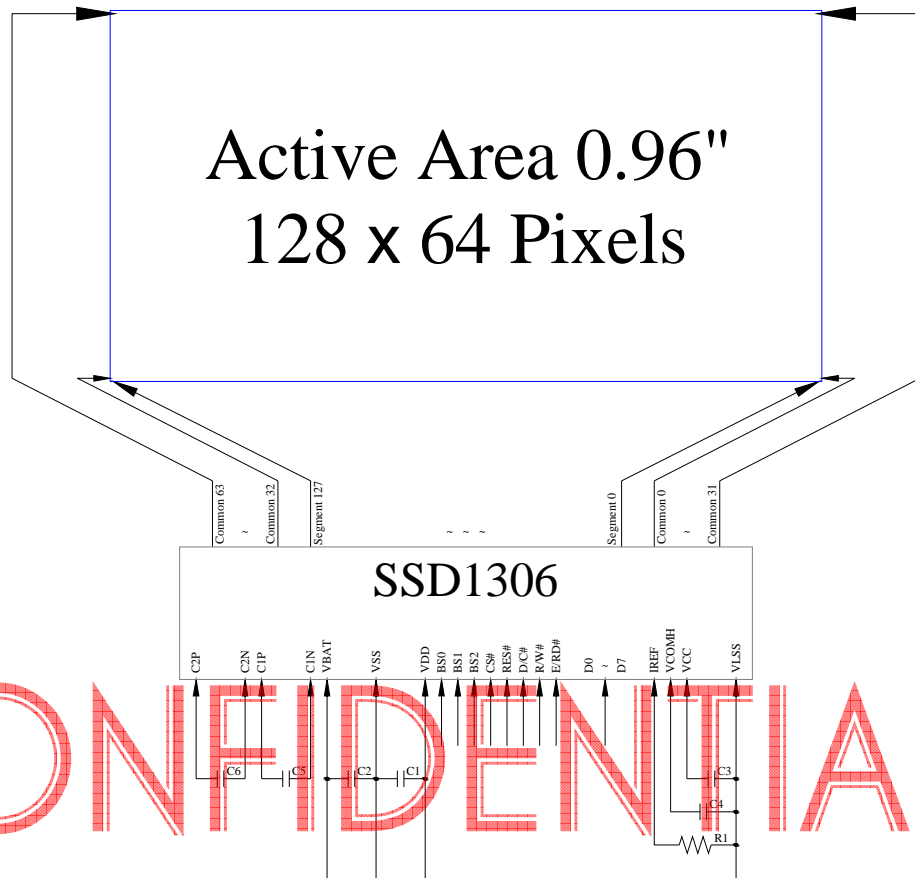Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and
                                  D0~D7

C1, C3: 0.1μF
C2:   2.2μF
C4, C5: 4.7μF / 16V, X7R
R1:   560kΩ, R1 = (Voltage at IREF – VSS) / IREF

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1.6.2 V_{CC} Generated by Internal DC/DC Circuit

Active Area 0.96"
128 x 64 Pixels

SSD1306

MCU Interface Selection: BS0, BS1 and BS2
Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7

C1, C2, C5, C6: 1μF
C3: 2.2μF
C4: 4.7μF / 16V, X7R
R1: 390kΩ, R1 = (Voltage at IREF – VSS) / IREF

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2. *Absolute Maximum Ratings*

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	V_{DD}	-0.3	4	V	1, 2
Supply Voltage for Display	V_{CC}	0	11	V	1, 2
Supply Voltage for DC/DC	*V_{BAT}*	*-0.3*	*5*	*V*	*1, 2*
Operating Temperature	T_{OP}	-30	70	°C	-
Storage Temperature	T_{STG}	-40	80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

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3. Optics & Electrical Characteristics

3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Brightness (V_{CC} Supplied Externally)	L_{br}	With Polarizer (Note 3)	100	120	-	cd/m^2
Brightness (V_{CC} Generated by Internal DC/DC)	*L_{br}*	*With Polarizer (Note 4)*	*80*	*100*	*-*	*cd/m^2*
C.I.E. (Blue)	(x) (y)	Without Polarizer	0.12 0.22	0.16 0.26	0.20 0.30	
C.I.E. (Yellow)	(x) (y)	Without Polarizer	0.44 0.46	0.48 0.50	0.52 0.54	
Dark Room Contrast	CR		-	>2000:1	-	
View Angle			>160	-	-	degree

* Optical measurement taken at V_{DD} = 2.8V, V_{CC} = 9V & *7.25V*.
Software configuration follows Section 4.4 Initialization.

3.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Supply Voltage for Logic	V_{DD}	-	1.65	2.8	3.3	V
Supply Voltage for Display (Supplied Externally)	V_{CC}	Note 3	8.5	9	9.5	V
Supply Voltage for DC/DC	*V_{BAT}*	*Internal DC/DC Enable*	*3.5*	*-*	*4.2*	*V*
Supply Voltage for Display (Generated by Internal DC/DC)	*V_{CC}*	*Note 4*	*7*	*7.25*	*7.5*	*V*
High Level Input	V_{IH}	-	0.8×V_{DD}	-	V_{DD}	V
Low Level Input	V_{IL}	-	0	-	0.2×V_{DD}	V
High Level Output	V_{OH}	I_{OUT} = 100µA, 3.3MHz	0.9×V_{DD}	-	V_{DD}	V
Low Level Output	V_{OL}	I_{OUT} = 100µA, 3.3MHz	0	-	0.1×V_{DD}	V
Operating Current for V_{DD}	I_{DD}	-	-	180	300	µA
Operating Current for V_{CC} (V_{CC} Supplied Externally)	I_{CC}	Note 5	-	7.3	9.1	mA
		Note 6	-	12.3	15.4	mA
Operating Current for V_{BAT} (V_{CC} Generated by Internal DC/DC)	*I_{BAT}*	*Note 7*	*-*	*18.8*	*23.5*	*mA*
		Note 8	*-*	*25.6*	*32.0*	*mA*
Sleep Mode Current for V_{DD}	$I_{DD, SLEEP}$	-	-	1	5	µA
Sleep Mode Current for V_{CC}	$I_{CC, SLEEP}$	-	-	1	5	µA

Note 3 & 4: Brightness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customer's request.
Note 5: V_{DD} = 2.8V, V_{CC} = 9V, 50% Display Area Turn on.
Note 6: V_{DD} = 2.8V, V_{CC} = 9V, 100% Display Area Turn on.
Note 7: V_{DD} = 2.8V, V_{CC} = 7.25V, 50% Display Area Turn on.

*Note 8:* *V_{DD} = 2.8V, V_{CC} = 7.25V, 100% Display Area Turn on.*

* Software configuration follows Section 4.4 Initialization.

3.3 AC Characteristics

3.3.1 68XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	0	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	7	-	ns
t_{DHR}	Read Data Hold Time	20	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (Read)	120	-	ns
	Chip Select Low Pulse width (Write)	60		
PW_{CSH}	Chip Select High Pulse Width (Read)	60	-	ns
	Chip Select High Pulse Width (Write)	60		
t_R	Rise Time	-	40	ns
t_F	Fall Time	-	40	ns

* (V_{DD} - V_{SS} = 1.65V to 3.3V, T_a = 25°C)

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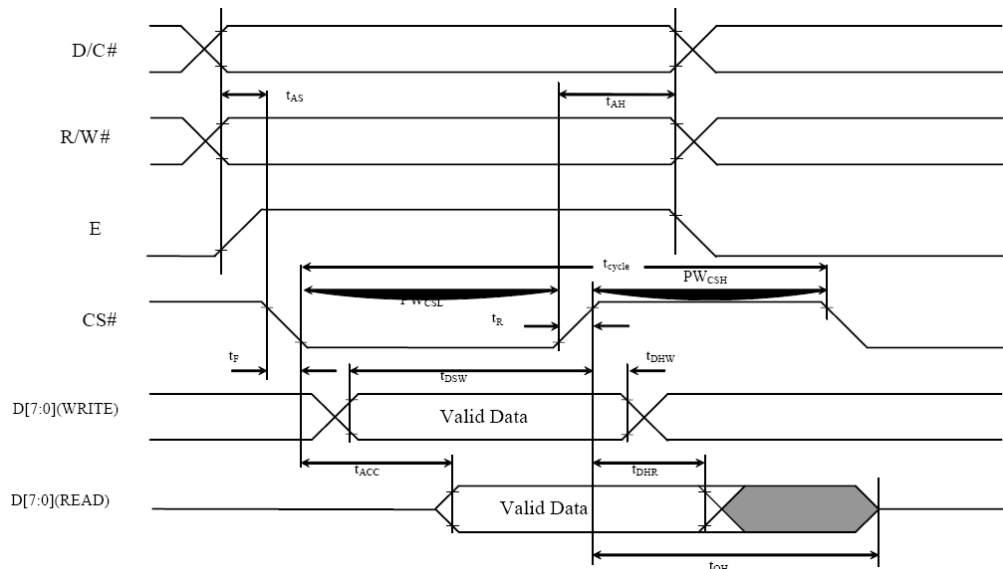
3.3.2 80XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	10	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	7	-	ns
t_{DHR}	Read Data Hold Time	20	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
t_{PWLR}	Read Low Time	120	-	ns
t_{PWLW}	Write Low Time	60	-	ns
t_{PWHR}	Read High Time	60	-	ns
t_{PWHW}	Write High Time	60	-	ns
t_{CS}	Chip Select Setup Time	0	-	ns
t_{CSH}	Chip Select Hold Time to Read Signal	0	-	ns
t_{CSF}	Chip Select Hold Time	20	-	ns
t_R	Rise Time	-	40	ns
t_F	Fall Time	-	40	ns

* ($V_{DD} - V_{SS} = 1.65V$ to $3.3V$, $T_a = 25°C$)

(*Read Timing*)

(*Write Timing*)
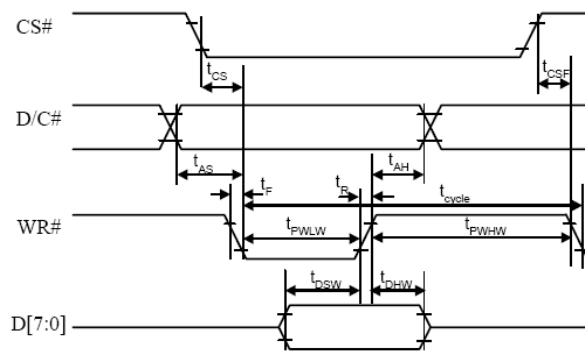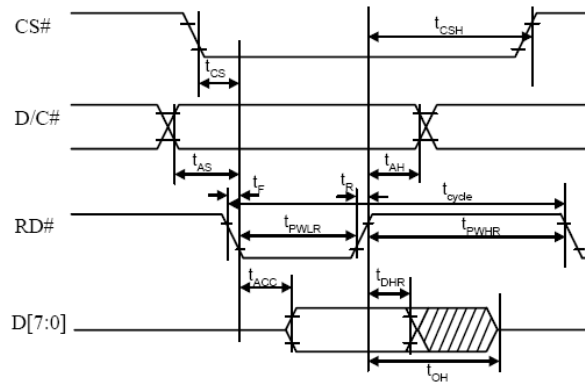
3.3.3 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	100	-	ns
t_{AS}	Address Setup Time	15	-	ns
t_{AH}	Address Hold Time	15	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t_{CSH}	Chip Select Hold Time	10	-	ns
t_{DSW}	Write Data Setup Time	15	-	ns
t_{DHW}	Write Data Hold Time	15	-	ns
t_{CLKL}	Clock Low Time	20	-	ns
t_{CLKH}	Clock High Time	20	-	ns
t_R	Rise Time	-	40	ns
t_F	Fall Time	-	40	ns

* $(V_{DD} - V_{SS} = 1.65V$ to $3.3V$, $T_a = 25°C)$
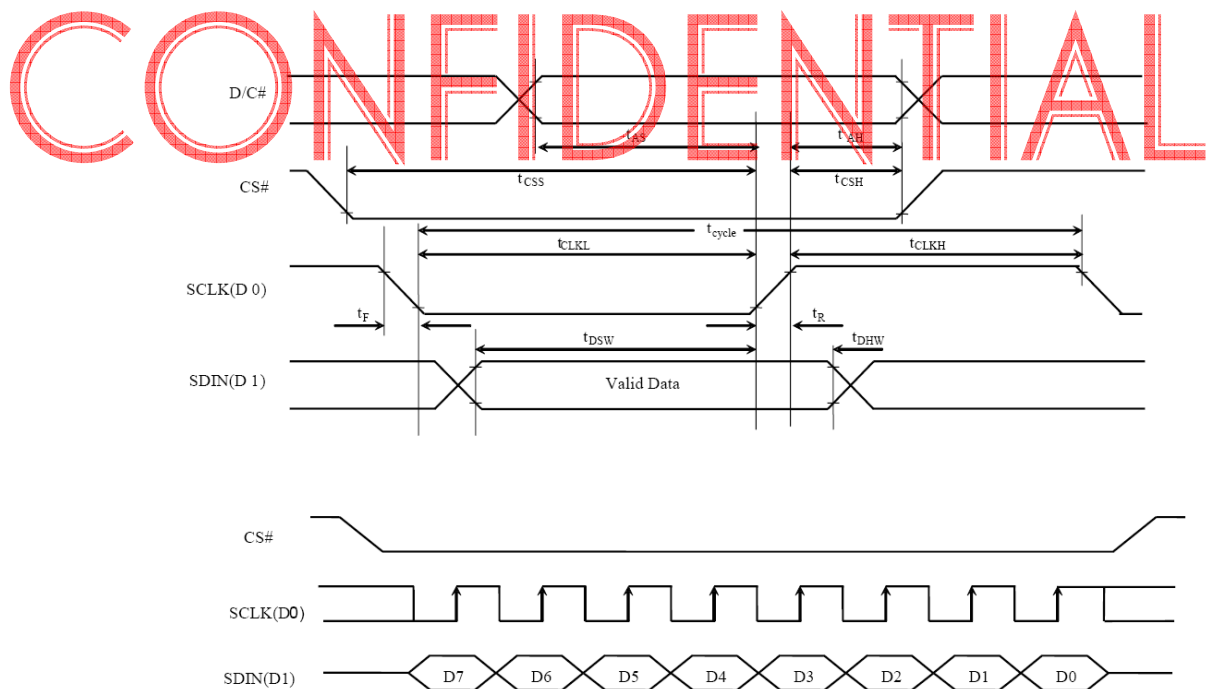
3.3.4 Serial Interface Timing Characteristics: (3-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	100	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t_{CSH}	Chip Select Hold Time	10	-	ns
t_{DSW}	Write Data Setup Time	15	-	ns
t_{DHW}	Write Data Hold Time	15	-	ns
t_{CLKL}	Clock Low Time	20	-	ns
t_{CLKH}	Clock High Time	20	-	ns
t_R	Rise Time	-	40	ns
t_F	Fall Time	-	40	ns

* $(V_{DD} - V_{SS} = 1.65V$ to $3.3V$, $T_a = 25°C)$

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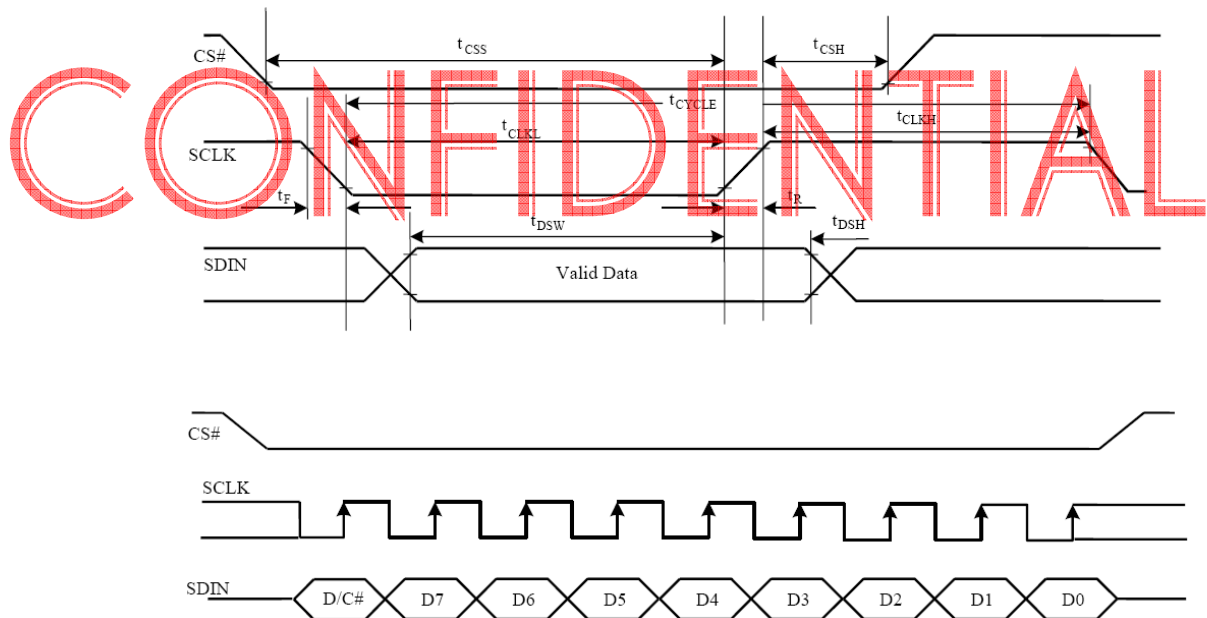
3.3.5 I^2C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	2.5	-	us
t_{HSTART}	Start Condition Hold Time	0.6	-	us
t_{HD}	Data Hold Time (for "SDA$_{OUT}$" Pin)	0	-	ns
	Data Hold Time (for "SDA$_{IN}$" Pin)	300		
t_{SD}	Data Setup Time	100	-	ns
t_{SSTART}	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	us
t_{SSTOP}	Stop Condition Setup Time	0.6	-	us
t_R	Rise Time for Data and Clock Pin		300	ns
t_F	Fall Time for Data and Clock Pin		300	ns
t_{IDLE}	Idle Time before a New Transmission can Start	1.3	-	us

* (V_{DD} - V_{SS} = 1.65V to 3.3V, T_a = 25°C)

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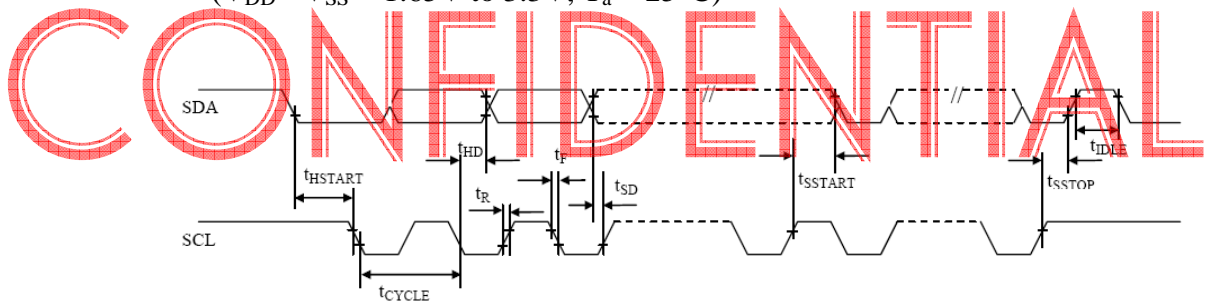
## 4. Functional Specification

4.1. Commands

Refer to the Technical Manual for the SSD1306

4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.
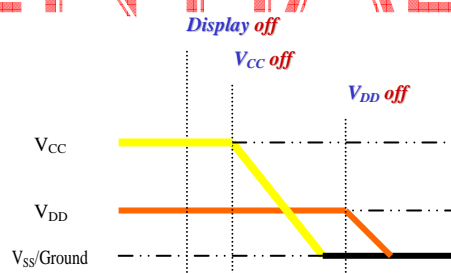
4.2.1 Power up Sequence:

1. Power up V_{DD}
2. Send Display off command
3. Initialization
4. Clear Screen
5. Power up V_{CC}
6. Delay 100ms
    (When V_{CC} is stable)
7. Send Display on command
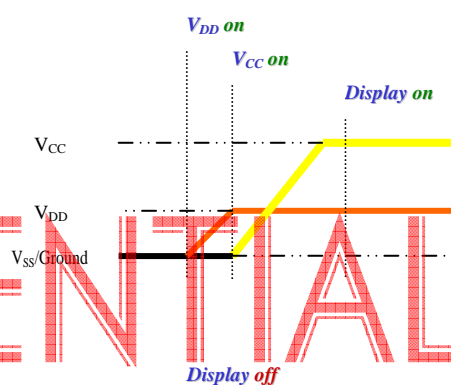
4.2.2 Power down Sequence:

1. Send Display off command
2. Power down V_{CC}
3. Delay 100ms
    (When V_{CC} is reach 0 and panel is completely discharges)
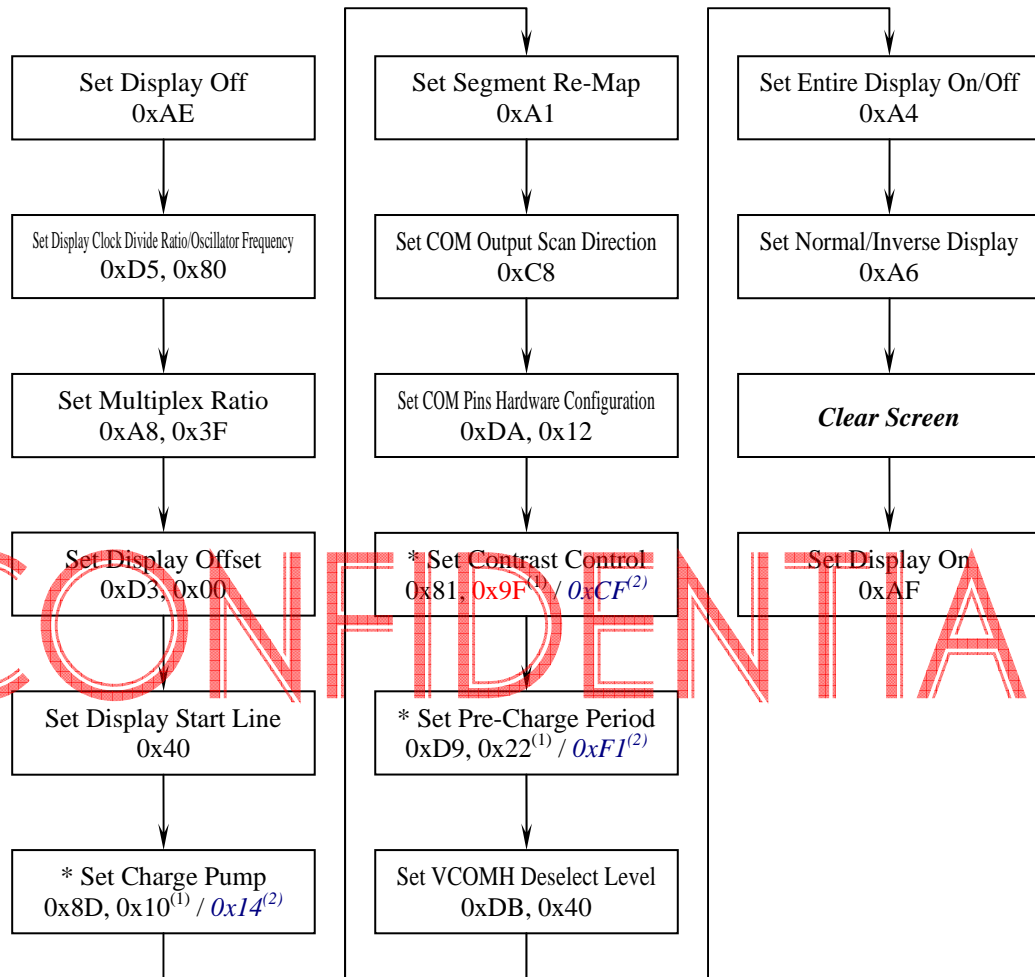4. Power down V_{DD}

4.3 Reset Circuit

When RES# input is low, the chip is initialized with the following status:
1. Display is OFF
2. 128×64 Display Mode
3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
4. Shift register data clear in serial interface
5. Display start line is set at display RAM address 0
6. Column address counter is set at 0
7. Normal scan direction of the COM outputs
8. Contrast control register is set at 7Fh
9. Normal display mode (Equivalent to A4h command)

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4.4 Actual Application Example

Command usage and explanation of an actual example

<Initialization>

Set Display Off 0xAE	Set Segment Re-Map 0xA1	Set Entire Display On/Off 0xA4
Set Display Clock Divide Ratio/Oscillator Frequency 0xD5, 0x80	Set COM Output Scan Direction 0xC8	Set Normal/Inverse Display 0xA6
Set Multiplex Ratio 0xA8, 0x3F	Set COM Pins Hardware Configuration 0xDA, 0x12	*Clear Screen*
Set Display Offset 0xD3, 0x00	* Set Contrast Control 0x81, 0x9F[1] / *0xCF[2]*	Set Display On 0xAF
Set Display Start Line 0x40	* Set Pre-Charge Period 0xD9, 0x22[1] / *0xF1[2]*	
* Set Charge Pump 0x8D, 0x10[1] / *0x14[2]*	Set VCOMH Deselect Level 0xDB, 0x40	

* Written Value for Parameters
[1] ➔ V_{CC} Supplied Externally
[2] ➔ *V_{CC} Generated by Internal DC/DC Circuit*

If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

5. Reliability

5.1 Contents of Reliability Tests

Item	Conditions	Criteria
High Temperature Operation	70°C, 240 hrs	
Low Temperature Operation	-30°C, 240 hrs	
High Temperature Storage	80°C, 240 hrs	
Low Temperature Storage	-40°C, 240 hrs	The operational functions work.
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs	
Thermal Shock	-40°C $\Leftrightarrow$ 85°C, 24 cycles 60 mins dwell	

* The samples used for the above tests do not include polarizer.
* No moisture condensation is observed during tests.

5.2 Lifetime

End of lifetime is specified as 50% of initial brightness reached.

Parameter	Min	Max	Unit	Condition	Notes
Operating Life Time	10,000	-	hr	100 cd/m^2, 50% Checkerboard	6
Storage Life Time	20,000	-	hr	$T_a = 25$°C, 50% RH	-

Note 6: The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

5.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.

6. Outgoing Quality Control Specifications

6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:	$23 \pm 5°C$
Humidity:	55 ± 15 %RH
Fluorescent Lamp:	30W
Distance between the Panel & Lamp:	≥ 50 cm
Distance between the Panel & Eyes of the Inspector:	≥ 30 cm

Finger glove (or finger cover) must be worn by the inspector.
Inspection table or jig must be anti-electrostatic.
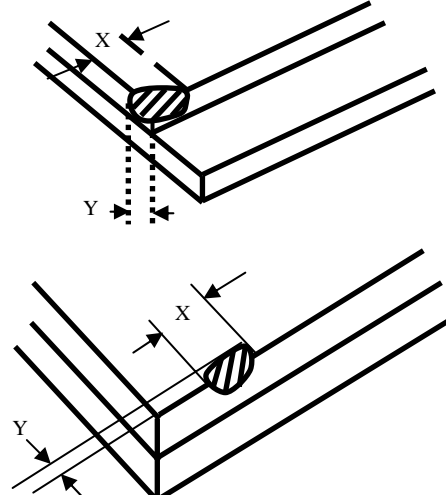
6.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E
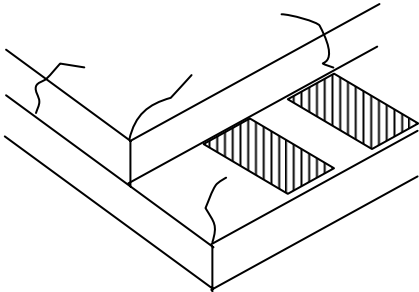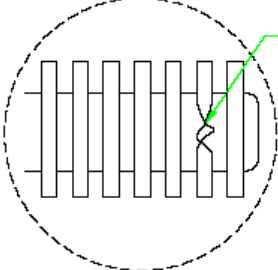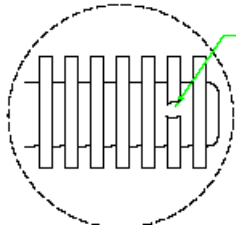
6.3 Criteria & Acceptable Quality Level

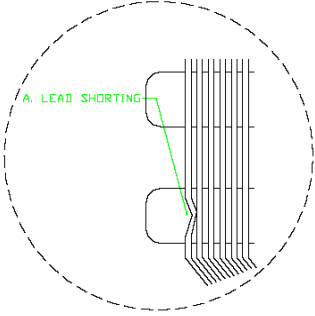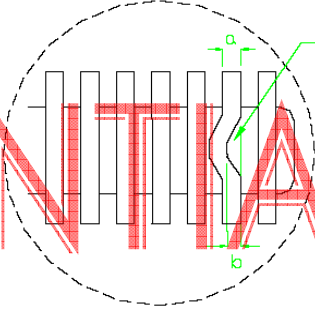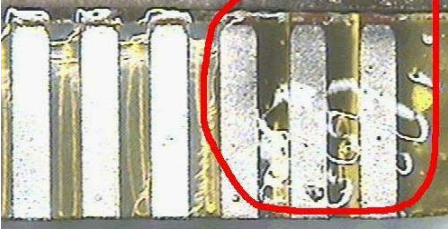| Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

6.3.1 Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)

6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

Check Item	Classification	Criteria
Panel Crack	Minor	Any crack is not allowable.
Cupper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	
Terminal Lead Twist	Minor	Not Allowable
Terminal Lead Broken	Minor	Not Allowable
Terminal Lead Prober Mark	Acceptable	

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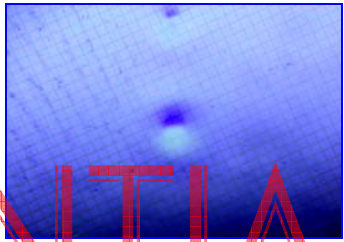
6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

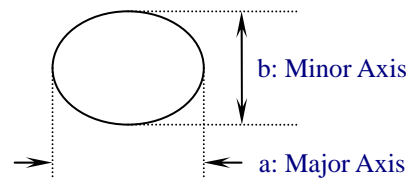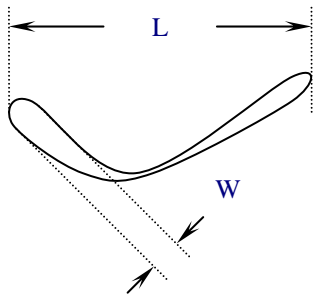| Check Item	Classification	Criteria
Terminal Lead Bent (Not Twist or Broken)	Minor	NG if any bent lead cause lead shorting.
	Minor	NG for horizontally bent lead more than 50% of its width.
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

6.3.2 Cosmetic Check (Display Off) in Active Area

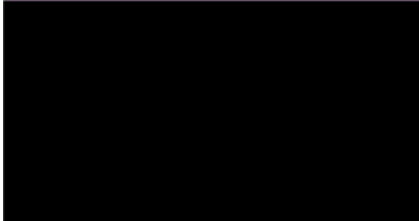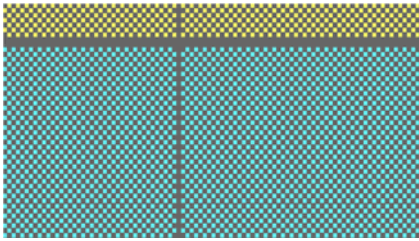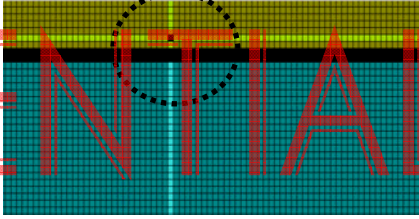| Check Item	Classification	Criteria	
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affect the Polarizer	
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W \leq 0.1$ $W > 0.1, L \leq 2$ $L > 2$	Ignore $n \leq 1$ $n = 0$
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$\Phi \leq 0.1$ $0.1 < \Phi \leq 0.25$ $0.25 < \Phi$	Ignore $n \leq 1$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	$\Phi \leq 0.5$ ➔ Ignore if no Influence on Display $0.5 < \Phi$	 $n = 0$
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable	
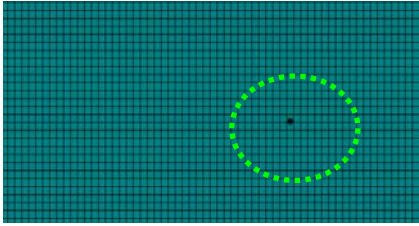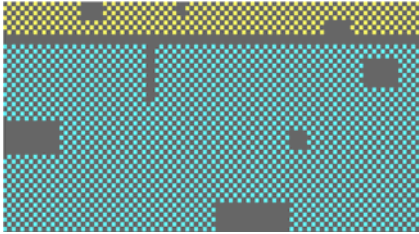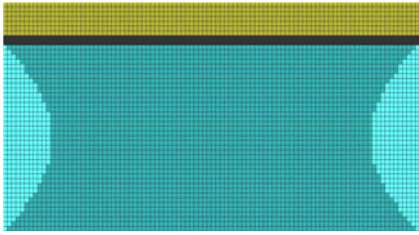
* Protective film should not be tear off when cosmetic check.

** Definition of W & L & Φ (Unit: mm): $\Phi = (a + b) / 2$

L

W

b: Minor Axis

a: Major Axis

6.3.3 Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Flicker	Major	Not Allowable
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	

7. Package Specifications

EPE COVER FOAM 351x212x1,
ANTISTATIC x 1 Pcs

Module

Tray 420x285 T=0.8mm

x 1 pcs (Empty)

x **A** pcs   Staggered Stacking

Wrapped with adhesive tape
x **B** pcs

Vacuum packing bag

EPE PROTECTTIVE
370mm x 280mm x 20mm

Primary L450mm x W296 x H110, B wave
x **C** Pcs

Label

Carton Box L464mm x W313mm x H472mm, AB wave
(Major / Maximum)

B Pcs Tray Vacuum packing

EPE PROTECTTIVE

Primary Box **C** SET

CARTON BOX

Label

| Univision Technology Inc. |
| Part ID : |
| Lot ID : |
| Q'ty : |
| QC : |

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| Item		Quantity	
Holding Trays	**(A)**	15	per Primary Box
Total Trays	**(B)**	16	per Primary Box (Including 1 Empty Tray)
Primary Box	**(C)**	1~4	per Carton (4 as Major / Maximum)

8. Precautions When Using These OEL Display Modules

8.1 Handling Precautions

1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.

2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.

3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.

4) The polarizer covering the surface of the OEL display module is soft and easily scratched.   Please be careful when handling the OEL display module.

5) When the surface of the polarizer of the OEL display module has soil, clean the surface.   It takes advantage of by using following adhesion tape.
   * Scotch Mending Tape No. 810 or an equivalent
   Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
   Also, pay attention that the following liquid and solvent may spoil the polarizer:
   * Water
   * Ketone
   * Aromatic Solvents

6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module.   And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance.   Also, secure sufficient rigidity for the outer cases.
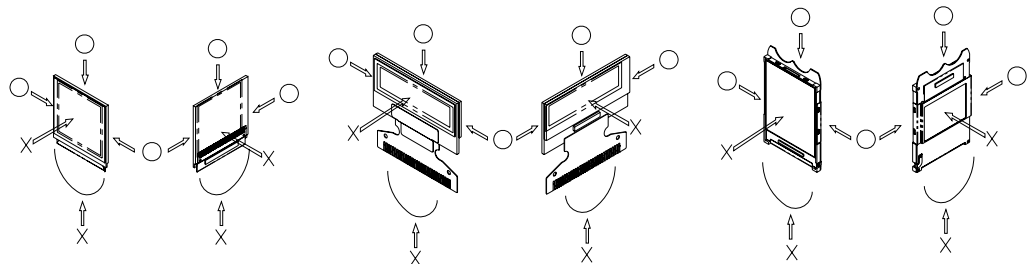
7) Do not apply stress to the LSI chips and the surrounding molded sections.

8) Do not disassemble nor modify the OEL display module.

9) Do not apply input signals while the logic power is off.

10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
   * Be sure to make human body grounding when handling OEL display modules.
   * Be sure to ground tools to use or assembly such as soldering irons.
   * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
   * Protective film is being applied to the surface of the display panel of the OEL display module.   Be careful since static electricity may be generated when exfoliating the protective film.

11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film.   In such case, remove the residue material by the method introduced in the above Section 5).

12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

8.2 Storage Precautions

1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments.   (We recommend you to store these modules in the packaged state when they were shipped from Univision Technology Inc.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

8.3 Designing Precautions

1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.

2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.

3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD).   (Recommend value: 0.5A)

4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

5) As for EMI, take necessary measures on the equipment side basically.

6) When fastening the OEL display module, fasten the external plastic housing section.

7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.

8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1306

   * Connection (contact) to any other potential than the above may lead to rupture of the IC.

8.4   Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

8.5   Other Precautions

1) When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
* Pins and electrodes
* Pattern layouts such as the FPC

3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
* Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
* Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.

4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.